Low Voltage Precision Adjustable Shunt Regulator

The TLV431A and B series are precision low voltage shunt regulators that are programmable over a wide voltage range of 1.24 V to 16 V. The TLV431A series features a guaranteed reference accuracy of ±1.0% at 25°C and ±2.0% over the entire industrial temperature range of -40°C to 85°C. For TLV431B series, the accuracy is even higher, it's $\pm 0.5\%$ and $\pm 1.0\%$ respectively. These devices exhibit a sharp low current turn-on characteristic with a low dynamic impedance of 0.20 Ω over an operating current range of 100 μ A to 20 mA. This combination of features makes this series an excellent replacement for zener diodes in numerous applications circuits that require a precise reference voltage. When combined with an optocoupler, the TLV431A/B can be used as an error amplifier for controlling the feedback loop in isolated low output voltage (3.0 V to 3.3 V) switching power supplies. These devices are available in economical TO-92-3 and micro size TSOP-5 and SOT-23-3 packages.

Features

- Programmable Output Voltage Range of 1.24 V to 16 V
- Voltage Reference Tolerance ±1.0% for A Series and ±0.5% for B Series
- Sharp Low Current Turn-On Characteristic
- Low Dynamic Output Impedance of 0.20 Ω from 100 μA to 20 mA
- Wide Operating Current Range of 50 µA to 20 mA
- Micro Miniature TSOP-5, SOT-23-3 and TO-92-3 Packages
- These are Pb-Free and Halide-Free Devices
- SCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable

Applications

- Low Output Voltage (3.0 V to 3.3 V) Switching Power Supply Error Amplifier
- Adjustable Voltage or Current Linear and Switching Power Supplies
- Voltage Monitoring
- Current Source and Sink Circuits
- Analog and Digital Circuits Requiring Precision References
- Low Voltage Zener Diode Replacements

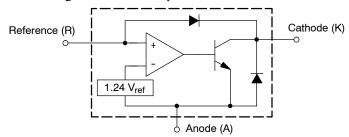
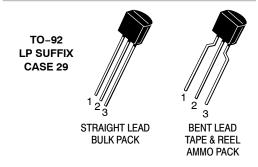


Figure 1. Representative Block Diagram



ON Semiconductor®

http://onsemi.com





TSOP-5 SN SUFFIX CASE 483



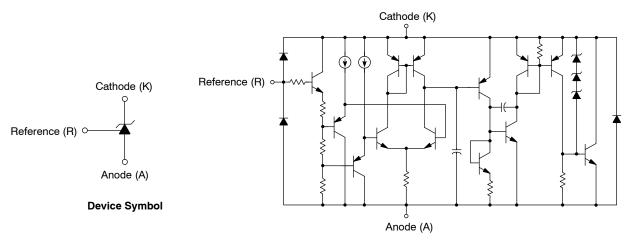
SOT-23-3 SN1 SUFFIX CASE 318

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 11 of this data sheet.

DEVICE MARKING INFORMATION AND PIN CONNECTIONS

See general marking information in the device marking section on page 10 of this data sheet.



The device contains 13 active transistors.

Figure 2. Representative Device Symbol and Schematic Diagram

MAXIMUM RATINGS (Full operating ambient temperature range applies, unless otherwise noted)

Rating	Symbol	Value	Unit
Cathode to Anode Voltage	V _{KA}	18	V
Cathode Current Range, Continuous	Ι _Κ	-20 to 25	mA
Reference Input Current Range, Continuous	I _{ref}	-0.05 to 10	mA
Thermal Characteristics LP Suffix Package, TO-92-3 Package Thermal Resistance, Junction-to-Ambient Thermal Resistance, Junction-to-Case SN Suffix Package, TSOP-5 Package Thermal Resistance, Junction-to-Ambient SN1 Suffix Package, SOT-23-3 Package Thermal Resistance, Junction-to-Ambient	R _{OJA} R _{OJC} R _{OJA}	178 83 226 491	°C/W
Operating Junction Temperature	TJ	150	°C
Operating Ambient Temperature Range	T _A	- 40 to 85	°C
Storage Temperature Range	T _{stg}	- 65 to 150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

NOTE: This device series contains ESD protection and exceeds the following tests: Human Body Model 2000 V per MIL-STD-883, Method 3015. Machine Model Method 200 V.

$$P_{D} = \frac{T_{J(max)} - T_{A}}{R_{\theta,JA}}$$

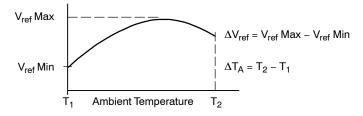
RECOMMENDED OPERATING CONDITIONS

Condition	Symbol	Min	Max	Unit
Cathode to Anode Voltage	V_{KA}	V_{ref}	16	V
Cathode Current	Ι _Κ	0.1	20	mA

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

	TLV431A/SCV431A		TLV43	TLV431B/SCV431B				
Characteristic	Symbol	Min	Тур	Max	Min	Тур	Max	Unit
Reference Voltage (Figure 3) $(V_{KA} = V_{ref}, I_K = 10 \text{ mA}, T_A = 25^{\circ}\text{C})$ $(T_A = T_{low} \text{ to } T_{high}, \text{ Note 1})$		1.228 1.215	1.240	1.252 1.265	1.234 1.228	1.240	1.246 1.252	V
Reference Input Voltage Deviation Over Temperature (Figure 3) $(V_{KA} = V_{ref}, I_{K} = 10 \text{ mA}, T_A = T_{low} \text{ to } T_{high}, \text{ Note 1})$	ΔV_{ref}	-	7.2	20	_	7.2	20	mV
Ration of Reference Input Voltage Change to Cathode Voltage Change (Figure 4) $(V_{KA} = V_{ref} \text{ to 16 V}, I_{K} = 10 \text{ mA})$	$\frac{\Delta V_{ref}}{\Delta V_{KA}}$	-	-0.6	-1.5	-	-0.6	-1.5	mV V
Reference Terminal Current (Figure 4) ($I_K = 10 \text{ mA}, R1 = 10 \text{ k}\Omega, R2 = \text{open}$)	I _{ref}	-	0.15	0.3	_	0.15	0.3	μΑ
Reference Input Current Deviation Over Temperature (Figure 4) ($I_K = 10 \text{ mA}$, R1 = 10 k Ω , R2 = open, Notes 1, 2)		-	0.04	0.08	-	0.04	0.08	μΑ
Minimum Cathode Current for Regulation (Figure 3)	I _{K(min})	-	55	80	-	55	80	μΑ
Off–State Cathode Current (Figure 5) $(V_{KA} = 6.0 \text{ V}, V_{ref} = 0)$ $(V_{KA} = 16 \text{ V}, V_{ref} = 0)$	I _{K(off)}	- -	0.01 0.012	0.04 0.05	- -	0.01 0.012	0.04 0.05	μΑ
Dynamic Impedance (Figure 3) $(V_{KA} = V_{ref}, I_K = 0.1 \text{ mA to } 20 \text{ mA, } f \leq 1.0 \text{ kHz, Note } 3)$		-	0.25	0.4	-	0.25	0.4	Ω

- Ambient temperature range: $T_{low} = -40^{\circ}C$, $T_{high} = 85^{\circ}C$. The deviation parameters ΔV_{ref} and ΔI_{ref} are defined as the difference between the maximum value and minimum value obtained over the full operating ambient temperature range that applied.



The average temperature coefficient of the reference input voltage, αV_{ref} is defined as:

$$\alpha V_{ref} \left(\frac{ppm}{^{\circ}C} \right) = \frac{\left(\frac{(\Delta V_{ref})}{V_{ref} (T_{A} = 25^{\circ}C)} \times 10^{6} \right)}{\Delta T_{A}}$$

 αV_{ref} can be positive or negative depending on whether V_{ref} Min or V_{ref} Max occurs at the lower ambient temperature, refer to Figure 8. Example: ΔV_{ref} = 7.2 mV and the slope is positive,

$$V_{ref}$$
 @ 25°C = 1.241 V ΔT_A = 125°C

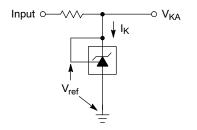
$$\alpha V_{ref} \left(\frac{ppm}{^{\circ}C} \right) = \frac{0.0072 \times 10^{6}}{1.241} = 46 \text{ ppm/}^{\circ}C$$

3. The dynamic impedance $Z_{\mbox{\scriptsize KA}}$ is defined as:

$$|Z_{KA}| = \frac{\Delta V_{KA}}{\Delta I_{K}}$$

When the device is operating with two external resistors, R1 and R2, (refer to Figure 4) the total dynamic impedance of the circuit is given by:

$$|Z_{KA}'| = |Z_{KA}| \times \left(1 + \frac{R1}{R2}\right)$$

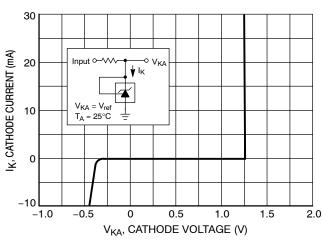


Input \circ \lor_{KA} Input \circ \lor_{KA} \lor_{KA}

Figure 3. Test Circuit for V_{KA} = V_{ref}

Figure 4. Test Circuit for $V_{KA} > V_{ref}$

Figure 5. Test Circuit for $I_{K(off)}$



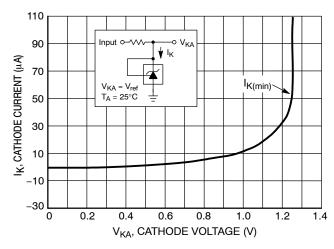
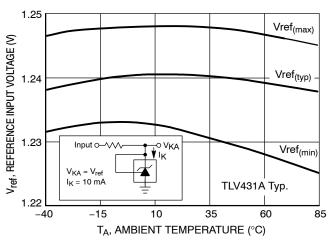


Figure 6. Cathode Current vs. Cathode Voltage

Figure 7. Cathode Current vs. Cathode Voltage



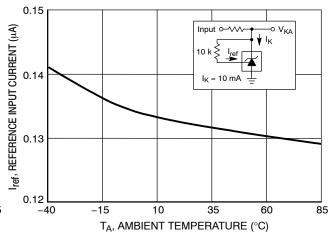


Figure 8. Reference Input Voltage versus Ambient Temperature

Figure 9. Reference Input Current versus
Ambient Temperature

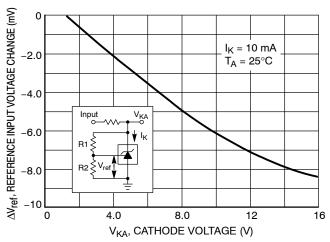
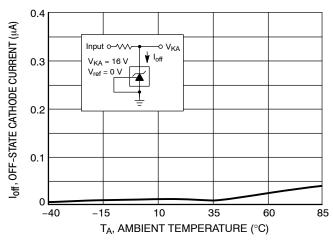


Figure 10. Reference Input Voltage Change versus Cathode Voltage

Figure 11. Off-State Cathode Current versus Cathode Voltage



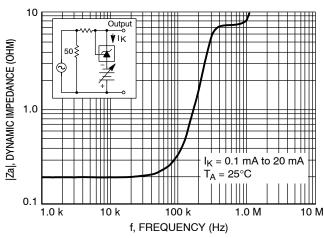
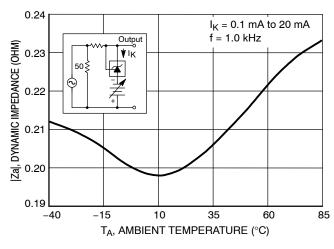


Figure 12. Off-State Cathode Current versus Ambient Temperature

Figure 13. Dynamic Impedance versus Frequency



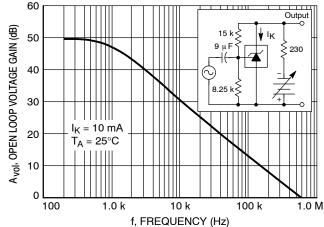
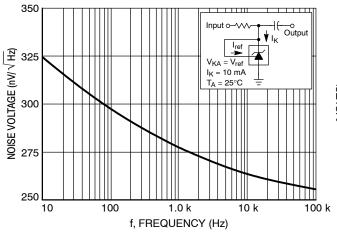


Figure 14. Dynamic Impedance versus Ambient Temperature

Figure 15. Open-Loop Voltage Gain versus Frequency



1.8 kΩ Output Generator = 100 kHz 1.5 Output 1.0 (VOLTS) T_A = 25°C 0.5 Input 0 2.0 0 2.0 6.0 7.0 1.0 3.0 4.0 5.0 8.0 10.0 t, TIME (μs)

Figure 16. Spectral Noise Density

Figure 17. Pulse Response

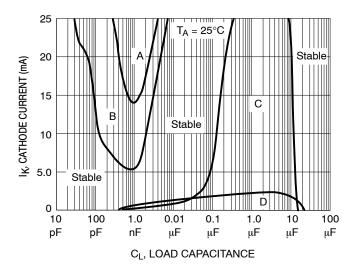
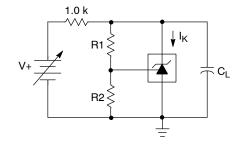


Figure 18. Stability Boundary Conditions



Unstable Regions	V _{KA} (V)	R1 (kΩ)	R2 (kΩ)
A, C	V_{ref}	0	8
B, D	5.0	30.4	10

Figure 19. Test Circuit for Figure 18

Stability

Figures 18 and 19 show the stability boundaries and circuit configurations for the worst case conditions with the load capacitance mounted as close as possible to the device. The required load capacitance for stable operation can vary depending on the operating temperature and capacitor

equivalent series resistance (ESR). Ceramic or tantalum surface mount capacitors are recommended for both temperature and ESR. The application circuit stability should be verified over the anticipated operating current and temperature ranges.

TYPICAL APPLICATIONS

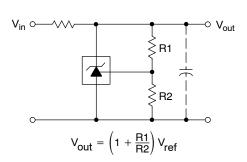


Figure 20. Shunt Regulator

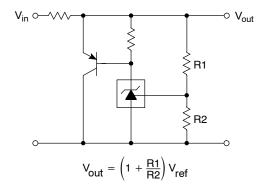


Figure 21. High Current Shunt Regulator

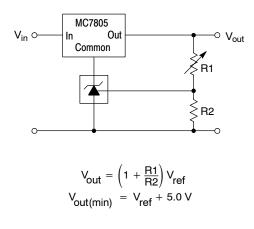


Figure 22. Output Control for a Three Terminal Fixed Regulator

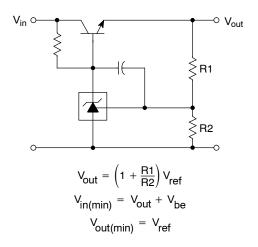


Figure 23. Series Pass Regulator

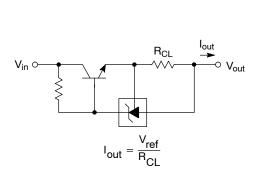


Figure 24. Constant Current Source

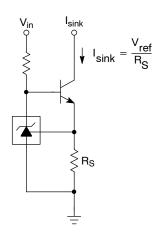


Figure 25. Constant Current Sink

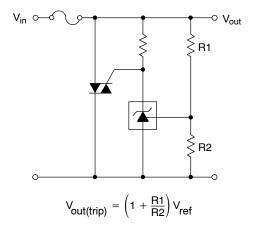


Figure 26. TRIAC Crowbar

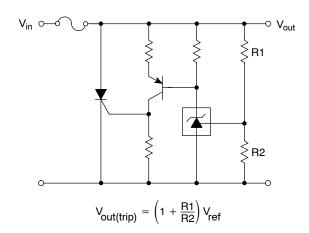
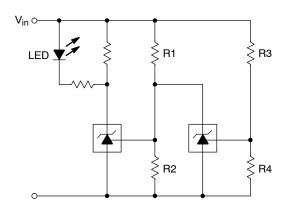


Figure 27. SCR Crowbar



L.E.D. indicator is 'ON' when $\mbox{\sc V}_{\mbox{\scriptsize in}}$ is between the upper and lower limits,

Lower limit =
$$\left(1 + \frac{R1}{R2}\right) V_{ref}$$

Upper limit = $\left(1 + \frac{R3}{R4}\right) V_{ref}$

Figure 28. Voltage Monitor

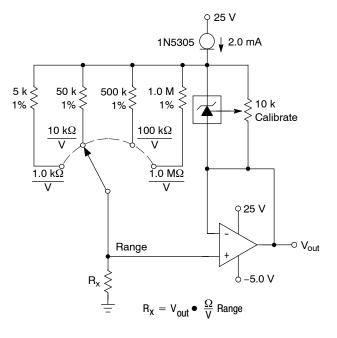


Figure 29. Linear Ohmmeter

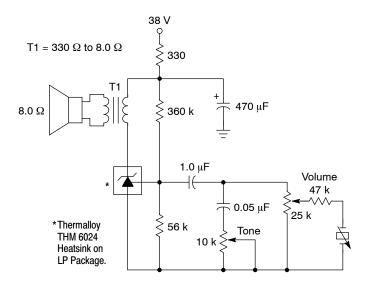


Figure 30. Simple 400 mW Phono Amplifier

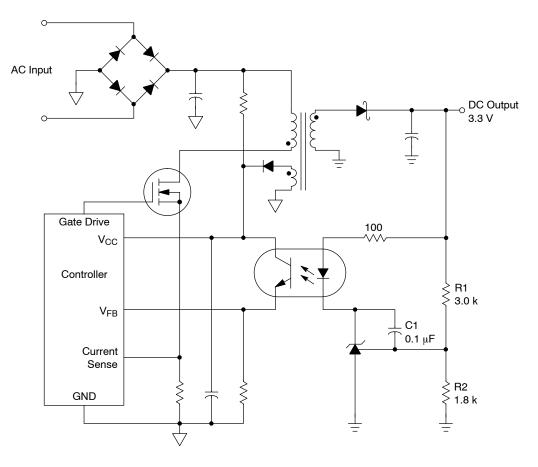
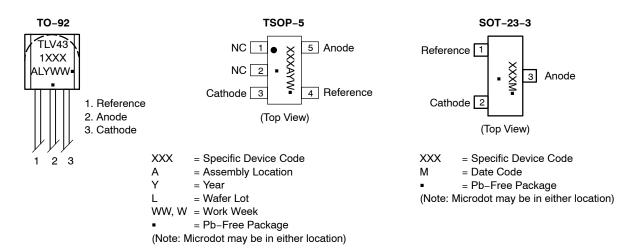


Figure 31. Isolated Output Line Powered Switching Power Supply

The above circuit shows the TLV431A/B as a compensated amplifier controlling the feedback loop of an isolated output line powered switching regulator. The output voltage is programmed to 3.3 V by the resistors values selected for R1 and R2. The minimum output voltage that can be programmed with this circuit is 2.64 V, and is limited by the sum of the reference voltage (1.24 V) and the forward drop of the optocoupler light emitting diode (1.4 V). Capacitor C1 provides loop compensation.

PIN CONNECTIONS AND DEVICE MARKING



ORDERING INFORMATION

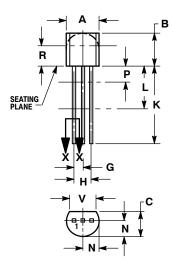
Device	Device Code	Package	Shipping [†]
TLV431ALPG	ALP	TO-92-3 (Pb-Free)	6000/Box
TLV431ALPRAG	ALP	TO-92-3 (Pb-Free)	2000/Tape & Reel
TLV431ALPREG	ALP	TO-92-3 (Pb-Free)	2000/Tape & Reel
TLV431ALPRMG	ALP	TO-92-3 (Pb-Free)	2000/Ammo Pack
TLV431ALPRPG	ALP	TO-92-3 (Pb-Free)	2000/Ammo Pack
TLV431ASNT1G	RAA	TSOP-5 (Pb-Free, Halide-Free)	3000/Tape & Reel
TLV431ASN1T1G	RAF	SOT-23-3 (Pb-Free, Halide-Free)	3000/Tape & Reel
TLV431BLPG	BLP	TO-92-3 (Pb-Free)	6000/Box
TLV431BLPRAG	BLP	TO-92-3 (Pb-Free)	2000/Tape & Reel
TLV431BLPREG	BLP	TO-92-3 (Pb-Free)	2000/Tape & Reel
TLV431BLPRMG	BLP	TO-92-3 (Pb-Free)	2000/Ammo Pack
TLV431BLPRPG	BLP	TO-92-3 (Pb-Free)	2000/Ammo Pack
TLV431BSNT1G	RAH	TSOP-5 (Pb-Free, Halide-Free)	3000/Tape & Reel
TLV431BSN1T1G	RAG	SOT-23-3 (Pb-Free, Halide-Free)	3000/Tape & Reel
SCV431ASN1T1G*	RAE	SOT-23-3 3000/Tape & (Pb-Free, Halide-Free)	
SCV431BSN1T1G*	RAC	SOT-23-3 (Pb-Free, Halide-Free)	3000/Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging

Specifications Brochure, BRD8011/D.
*SCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

PACKAGE DIMENSIONS

TO-92 (TO-226) **LP SUFFIX** CASE 29-11 **ISSUE AM**

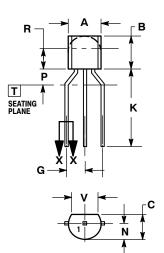


STRAIGHT LEAD **BULK PACK**



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
 4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.175	0.205	4.45	5.20
В	0.170	0.210	4.32	5.33
С	0.125	0.165	3.18	4.19
D	0.016	0.021	0.407	0.533
G	0.045	0.055	1.15	1.39
Н	0.095	0.105	2.42	2.66
7	0.015	0.020	0.39	0.50
K	0.500		12.70	
L	0.250		6.35	
N	0.080	0.105	2.04	2.66
P		0.100		2.54
R	0.115		2.93	
٧	0.135		3.43	



BENT LEAD **TAPE & REEL** AMMO PACK



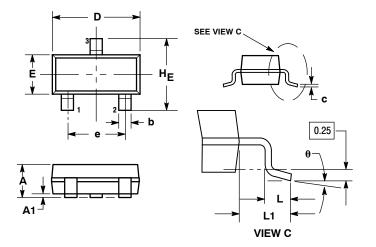
- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.

- CONTOUR OF PACKAGE BEYOND
 DIMENSION R IS UNCONTROLLED.
 LEAD DIMENSION IS UNCONTROLLED IN P
 AND BEYOND DIMENSION K MINIMUM.

	MILLIMETERS			
DIM	MIN	MAX		
Α	4.45	5.20		
В	4.32	5.33		
С	3.18	4.19		
D	0.40	0.54		
G	2.40	2.80		
J	0.39	0.50		
K	12.70			
N	2.04	2.66		
P	1.50	4.00		
R	2.93			
٧	3.43			

PACKAGE DIMENSIONS

SOT-23-3 **SN1 SUFFIX** CASE 318-08 **ISSUE AN**



NOTES:

- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

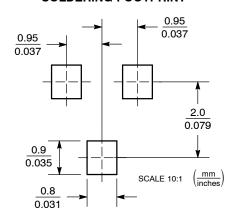
 2. CONTROLLING DIMENSION: INCH.

 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

 4. 318-01 THRU -07 AND -09 OBSOLETE, NEW STANDARD 318-08.

	MILLIMETERS			MILLIMETERS INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.89	1.00	1.11	0.035	0.040	0.044
A1	0.01	0.06	0.10	0.001	0.002	0.004
b	0.37	0.44	0.50	0.015	0.018	0.020
С	0.09	0.13	0.18	0.003	0.005	0.007
D	2.80	2.90	3.04	0.110	0.114	0.120
E	1.20	1.30	1.40	0.047	0.051	0.055
е	1.78	1.90	2.04	0.070	0.075	0.081
L	0.10	0.20	0.30	0.004	0.008	0.012
L1	0.35	0.54	0.69	0.014	0.021	0.029
HE	2.10	2.40	2.64	0.083	0.094	0.104

SOLDERING FOOTPRINT*

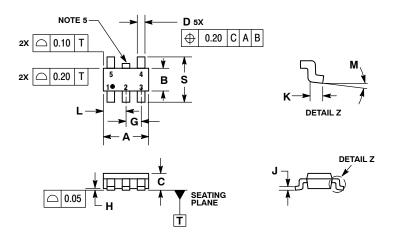


SOT-23-3

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PACKAGE DIMENSIONS

TSOP-5 **SN SUFFIX** CASE 483-02 **ISSUE H**

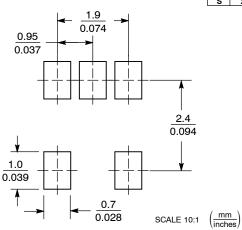


- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: MILLIMETERS.
 MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS
- OF BASE MATERIAL.

 4. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE
- OPTIONAL CONSTRUCTION: AN ADDITIONAL TRIMMED LEAD IS ALLOWED IN THIS LOCATION. TRIMMED LEAD NOT TO EXTEND MORE THAN 0.2 FROM BODY.

	MILLIMETERS			
DIM	MIN	MAX		
Α	3.00	BSC		
В	1.50	BSC		
С	0.90	1.10		
D	0.25	0.50		
G	0.95	BSC		
Н	0.01	0.10		
7	0.10	0.26		
K	0.20	0.60		
L	1.25	1.55		
М	0 °	10°		
S	2.50	3.00		

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and un are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of SCILLC's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking, pdf. SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for suspecific may which the failure of the SCILLC product could create a sixting when the failure of the SCILLC product could create a sixting when the failure of the SCILLC product could create a sixting when the representation when the second control of the science of the does not convey any license under its patient rights in the rights of others. SCILLC products are not designed, intended, or durinteed for use as components in systems intended to surgical implant into the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and resances, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada

Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada

Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative